Nanocrystalline Ni Coatings Strengthened with Ultrafine Particles

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In this study, nanocrystalline Ni powders and thermally sprayed coatings, containing ultrafine AlN particles, were synthesized and characterized. The results indicated that the presence of AlN particles in the powders drastically decreased the dimension of agglomerates formed by cryomilling and increased the surface roughness of the agglomerates. The AlN phase was broken down into ultrafine particles of approximately 30 nm in size. These particles were dispersed in the Ni matrix and enhanced the development of a nanocrystalline structure in the Ni matrix during cryomilling. Selected-area diffraction patterns, obtained from transmission electron microscopy (TEM) and X-ray mapping with scanning electron microscopy (SEM), confirmed the presence of AlN particles in the coatings. The presence of AlN particles also led to an increase in the amount of NiO phase that was distributed in the coating, in the form of ultrafine, round particles. AlN particles increased the microhardness of the Ni coating by approximately 60 pct. Indentation-fracture results also indicated that the fine, dispersed AlN particles raised the apparent toughness of the Ni coating. The synthesized Ni coatings containing ultrafine AlN particles were characterized as equiaxed nanocrystalline grains with an average size of 24 nm, in which twins were observed. The increase in microhardness resulted from both grain refinement and the presence of ultrafine particles. The latter played the primary role in strengthening.

through interactions with deformation faults^[1,2,3] and inhibiting grain growth due to Zener pinning.^[4,5] The contribu-
II. EXPERIMENTAL PROCEDURE tions of nitrides and oxides (formed through reactions
between powders and oxygen/nitrogen from the environment
during mechanical milling in liquid nitrogen) to the thermal
stability of nanocrystalline materials have been stability of nanocrystalline materials have been realized.^[6–9] particle size of $45 \pm 11 \mu$ m and AIN powder (CERAC Inc.,
Strengthening has also been found to result from the presence Milwaukee, WI) with a purity of 99 Strengthening has also been found to result from the presence
of ultrafine precipitates in nanostructured coatings.^[10,11] particle size of 1.97 μ m were selected for the present study.
Mechanical milling in liquid ni Mechanical milling in liquid nitrogen has been employed to The N₁ powders were blended with AlN powders for 0.5 synthesize nanocrystalling Ni powders which can be used hours in the amounts of 0, 0.5, and 2 wt pct AlN (or synthesize nanocrystalline Ni powders, which can be used
as feedstock powders to fabricate nanocrystalline Ni coat-
ings.^[12] However, Ni does not form a stable nitride in the
nitrogen atmosphere. In principle, the nitr \AA and $c = 4.306$ \AA), but the formation enthalpy of N₁₃N at capacity of 0.005/ m³. Stainless steel balls of 0.635 cm in componenture is quite low $(AH_{\text{one}} = 0.8 \text{ kJ/mol}^{[13]})$ diameter were used, with a powder-toroom temperature is quite low $(\Delta H_{298} = 0.8 \text{ kJ/mol}^{[13]})$, diameter were used, with a powder-to-ball mass ratio of indicating its instability at room temperature. Alternatively, 1:20. The powder charge was 1 kg. The mill From temperature is quite low $(\Delta H_{298} = 0.8 \text{ kJ/mol}^{[13]})$,

indicating its instability at room temperature. Alternatively,

the high hardness and thermal stability of aluminum nitride,

(AIN) are well known.^[14,15] The evolution and mechanical properties of nanocrystalline Ni/ ards, chemical analysis of the as-received and cryomilled
AlN coatings. Furthermore, we demonstrate that the AlN powders was conducted by Luvak Inc., a professiona

I. INTRODUCTION additions need not be in the nanometer scale at the start. THE significant performance enhancement that results
from the presence of small amounts of dispersed fine parti-
cles in materials is well recognized, *i.e.*, improving strength
during milling.

capacity of 0.0057 m³. Stainless steel balls of 0.635 cm in

cal-analysis company located in Boylston, MA. The particle size and distribution were determined using a particle analyzer made by Coulter Co. (Miami, FL).

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e-mail:jmschoenu substrates that were located at a distance of 0.230 m away

Table I. Spraying Parameters Used to Produce Ni with Aluminum Nitride Coatings

Gas	Pressure (MPa)	$GSF**$ $FMR*$		Parameters	Setting	
Air Propylene Oxygen	0.69 0.69 1.034	40 43 30	5616 1488 3410	powder feed rate X-Y traverse speed spraying distance	0.315 g/s 1.1016 m/s $0.230 \; \mathrm{m}$	
	$*FMR = flow$ meter reading. ** $GSF = gas$ standard flow (mm ³ /s).					

Five spray passes were performed for each coating. indicated by the arrows in Figure 1(d).

formed in the 2 θ range from 30 to 100 deg using Cu $K_{\alpha}(\lambda)$ = agglomerate size for the different powders. The as-received 0.15418 nm) radiation in a Siemens (Erlangen, Germany) Ni powder had a narrow size range with a median of 41 D5000 diffractometer equipped with a graphite monochromator. A low scanning rate of scans, with a step size of 0.01 μ m. Cryomilling increased the median size to 53 μ m and deg and a step time of 5 seconds, was used to assure the broadened the range of the size distribution. The increase detection of reflections from second phases with low percent-
agglomerate size caused by cryomilling has also been
ages. After the effects of K_{α} , were corrected, the peak posi-
observed in other fcc materials.^[22] tion and full-width at half-maximum of the XRD reflections of Ni were computed using a software package in the Sie- and an increase in the range of the size distribution, compared mens D5000 diffractometer. In the present work, the fully with cryomilled Ni powder. Consistent with the SEM morannealed Ni powder was used as a standard sample for the phological images, the median agglomerate size of the cryodetermination of instrumental broadening. Scanning elec- milled ($Ni + 0.5$ wt pct AlN) powders was measured to be tron microscopy (SEM) observations were performed on a 44μ m, slightly larger than that of the conventional Ni pow-PHILIPS* XL 30 microscope with a field-emission gun. der but 9 μ m smaller than the cryomilled Ni powder, and

*PHILIPS is a trademark of Philips Electronic Instruments Corp., Mah-
wah, NJ. powders drastically decreased to 17 μ m.
During cryomilling, morphological and dimensional

elsewhere,^[19] and the coating samples were prepared using and indentation cracking was examined using a Buehler and (b) show a uniform distribution of AlN particles (white

through (d) show morphological differences among the as- those shown in Figure 3. Milling caused the Ni powder received Ni powder (Figure 1(a)), the cryomilled Ni powder particles to continuously experience overlapping, welding, (Figure 1(b)), and the cryomilled ($Ni + AlN$) powders (Fig- and fracturing as a result of the collisions between the powures 1(c) and (d)). As a result of cryomilling, spherical der and the milling media. In such a process, the fine, hard Ni powders were transformed into irregular, flake-shaped AlN particles impacted with the larger Ni agglomerates and agglomerates. Compared to the smooth and well-defined were dispersively embedded into the Ni agglomerates.

from the nozzle of the spray gun. Before spraying, the surface agglomerate external surfaces of the cryomilled Ni powder of the substrate was grit blasted with abrasive A_2O_3 particles (Figure 1(b)), the agglomerate external surfaces of the cryoto create a superficial roughness, which improves the bond-
milled (Ni + 0.5 wt pct AlN) powde milled (Ni $+$ 0.5 wt pct AlN) powder became rougher due ing strength between the coating and the substrate. The spray to interaction with the hard particles (Figure $1(c)$). An facility and process are described in detail elsewhere,^[17,18] increase in the amount of hard particles to 2 wt pct led to and the spray parameters are listed in Table I. Four categories agglomerates breaking down into small, ragged fragments. of coatings were produced using the following powders: (1) The boundaries to these ragged fragments are difficult to the as-received Ni powders; (2) the cryomilled Ni powders; distinguish (Figure 1(d)), which is a common morphological (3) the cryomilled (Ni + 0.5 wt pct AlN) powders; and (4) the feature of mechanically milled composite powders.^[17,20,21] cryomilled (Ni + 2 wt pct AlN) powders. The corresponding Observation with high-resolution SEM has indicated that coatings are referred to in this manuscript as the conventional such agglomerates still consist of very fine particles.[20] It Ni coating, the cryo Ni coating, the cryo (Ni $+$ 0.5 wt pct is noted that in the present cryomilled (Ni $+$ 2 wt pct AlN) AlN) coating, and the cryo (Ni $+$ 2 wt pct AlN) coating. powder, a few uncrushed agglomerates are also seen, as

The X-ray diffraction (XRD) measurements were per- Figure 2 shows the distribution of powder particle/ μ m, consistent with their nominal particle size of 45 \pm 11 observed in other fcc materials.^[22] The addition of hard particles led to a decrease in the average agglomerate size the median agglomerate size of the cryomilled ($Ni + 2$ wt

Transmission electron microscopy (TEM) studies were con- changes occurred not only with respect to the agglomerate, ducted on a PHILIPS CM microscope operated at 200 keV; but also with respect to the second-phase, hard particles. the preparation of powder samples is described in detail After cryomilling the $(Ni + AIN)$ powders, the AlN particles elsewhere,^[19] and the coating samples were prepared using changed from their initial morphology as thin a standard grinding-dimpling–ion milling procedure. The with an average size of $1.97 \mu m$ into very fine round particles microhardness of the cross section of the coatings was tested, with an average size of approximately 30 nm. Figures 3(a) (Lake Bluff, IL) Micromet 2004 microhardness tester. particles) in the Ni matrix in the cryomilled (Ni $+$ 0.5 wt pct AlN) powders. The TEM bright-field image of the cryomilled ($Ni + 2$ wt pct AlN) powder is shown in Figure **III.** RESULTS AND DISCUSSION 4(a), in which grain boundaries are not clearly visible. Using A. *Powder Characteristics* reflections from the AlN particle, the dark-field image in the corresponding field was taken, and the result is shown The SEM secondary electron images in Figures 1(a) in Figure 4(b), indicating a consistent AlN particle size with

(*c*) (Ni + 0.5 wt pct AlN) powders cryomilled for 8 h at 100 K; and (*d*) (Ni + 2 wt pct AlN) powders cryomilled for 8 h at 100 K (arrows indicate uncrushed agglomerates).

Ni powder with a median size of 41 μ m; - \circ - cryomilled Ni powder with a median size of 53 μ m; - \blacktriangle - cryomilled (Ni + 0.5 wt pct AlN) powder with a median size of 44 μ m; and - \Diamond - cryomilled (Ni + 2 wt pct AlN) powder with a median size of 17 μ m.

the grain size of the cryomilled Ni, cryomilled (Ni $+$ 0.5

wt pct AlN), and cryomilled ($Ni + 2$ wt pct AlN) were calculated to be 105, 65, and 33 nm, respectively. These results indicate that the addition of hard AlN particles accelerated the formation of a nanocrystalline structure. In related studies, it was stated that the development of nanostructures in Zn and Cu-Ta systems during cryomilling evolved from the dynamic rearrangement of dislocations and recrystallization.[24,25] The steady-state grain sizes were achieved *via* the formation of new low-angle and then high-angle grain boundaries. The evolution of dislocation cell walls, the interpenetrating twin boundaries, the boundaries of deformation bands, or the nucleation and growth of new grains *via* dynamic recrystallization led to grain refinement. Sufficient energy stored in localized and highly strained regions caused by cryomilling induces or facilitates a recrystallization process in which new grains originate at the initial grain bound-Fig. 2—Distribution of powder particle/agglomerate size. $-$ conventional aries, but as the materials continue to be deformed, the dislocation density of the new grains increases, thus reducing the driving force for their further growth, and the recrystallizing grains eventually cease to grow. Therefore, grains remain in the nanometer dimension. Plastic damage occurs in the form of dislocations on the slip planes, whose density could On the basis of reflection line broadening of XRD, $[20,23]$ exceed 10^{13} lines/cm². In the range of dislocation densities of 10^{13} to $10^{14}/\text{cm}^2$, dislocation cores start to overlap and

(*b*)

Fig. 3—Distribution of AlN particles in the cryomilled (Ni $+$ 0.5 wt pct AlN) powders. (*a*) Distribution of AlN particles and (*b*) detailed view of the region indicated by the arrow in (a).

initialize dynamic recrystallization with small energy fluctuations.[24] In the present study, discontinuity of the crystal structure and the development of a heavy-strain field at the AIN/Ni interface lead to the emission and pileup of the Alivia interface lead to the emission and pileup of (*b*) (*b*)
dislocations, thereby increasing the dislocation density sig-
nificantly. Thus, the presence of hard particles accelerates Fig. 4—TEM images of the cryomi nificantly. Thus, the presence of hard particles accelerates Fig. 4—TEM images of the cryomilled (Ni + 2 wt pct AlN) powder. (*a*) origin refinement in the Ni matrix Physical fragmentation TEM bright-field image of cryomi grain refinement in the Ni matrix. Physical fragmentation
of initial coarse grains could be an additional factor for
improving the formation of a nanocrystalline structure by
improving the formation of a nanocrystalline s the addition of AlN particles. In a related study, the evolution of grains in the Ni-based superalloy INCONEL* 625 with is also possible for hard AlN particles to assist this physical

increasing cryomilling time was investigated by TEM in detail.^[22] The initial INCONEL 625 powder had equiaxed The results of the chemical-composition analysis for the grains, and grains were elongated after cryomilling for 4 powders are listed in Table II. For comparison purposes, the hours, similar to those observed in traditional cold-rolling/ nominal contents of aluminum and nitrogen for $(Ni + AIN)$ drawing materials. With increasing cryomilling time, pow-
ders experienced repeated fracturing,^[26] and the elongated from the AIN phase itself, were calculated and are also ders experienced repeated fracturing,^[26] and the elongated from the AlN phase itself, were calculated and are also grains (having a high deformation-fault density) in the pow-
grains (having a high deformation-fault den grains (having a high deformation-fault density) in the pow-
densities in Table II. The results show that cryomilling
ders were sheared into nanosized fragments by cycling
leads to noticeable contamination. The increase in ders were sheared into nanosized fragments by cycling leads to noticeable contamination. The increase in iron con-
impact loading in random directions. In other words, physi-
tent resulted from the wear of the stainless st impact loading in random directions. In other words, physical fragmentation of highly deformed, initially coarse grains tanks, shafts, and balls, which were severely worn by the

(*a*)

Fragmentation of initially coarse grains and to promote the *INCONEL is a trademark of INCO Alloys International, Huntington fragmentation of a nanocrystalline structure in the Ni matrix, formation of a nanocrystalline structure in the Ni matrix, because the hard particles impact and partition the powder agglomerates into small fragments, as seen in Figure $1(d)$.

facilitated the formation of the nanocrystalline structure. It powders containing hard particles. Neglecting the increase

Table II. Chemical Composition of the As-Received and Cryomilled Ni, Ni/AlN Powders (Weight Percent)

Code	Fe	ΑI			
As-received Ni	0.02	0.01	0.02	0.48	0.014
Cryomilled Ni	0.08	0.03	0.05	0.51	0.034
Cryomilled ($Ni + 0.5$ wt pct AlN)/nominal	0.14	0.36/0.33	0.23/0.17	0.94	0.031
Cryomilled ($Ni + 2$ wt pct AlN)/nominal	0.36	1.37/1.32	0.90/0.68	l.17	0.054

in aluminum content coming directly from AlN, an evident were present, shown in Figure 6(c). Mechanical twins are net change in aluminum content is not observed. In general, observed in the various cryomilled powders;^[19,22] thus, the the contents of nitrogen, oxygen, and carbon increased with presence of twins in the coating is probably from the preserincreasing AlN content in the cryomilled powders. These vation of twins in the feedstock powders, and the related elements originated from diffusion from the milling environ-
mechanism is discussed in detail elsewhere.^{[19} elements originated from diffusion from the milling environments.^[17,18,20,21] According to Table II, the net increase in In comparison with the microstructures of the cryo Ni nitrogen content is 0.06 and 0.32 wt pct for the cryomilled coating, the following microstructural features were $(Ni + 0.5$ wt pct AlN) and the cryomilled $(Ni + 2$ wt pct observed as a result of introducing 2 wt pct AlN particles AlN) powder, respectively. The presence of AlN particles into the Ni matrix: (1) a distinctive lamellar structure on SEM also caused a noticeable increase in oxygen. The increased cross-sectional images, indicating that significant oxidation external surface areas in the cryomilled $(N_i + A_iN)$ powders, occurred at the interpass boundaries; (2) smaller grain sizes because of the rougher surface and smaller powder agglom- in the coatings, consistent with the smaller grain sizes in erate size (Figures 1(c) and (d)), is the primary cause for the cryomilled (Ni + 2 wt pct AlN) powder; and (3) the the increase in the oxygen content and the net increase in presence of twins in the cryo $(Ni + 2$ wt pct AlN) coatings. nitrogen content. The microhardness of the different coatings in cross sec-

microstructures, observed with SEM, of the conventional AlN) and the cryo (Ni + 2 wt pct AlN) coatings, respectively.
Ni the cryo Ni and the cryo (Ni + 0.5 wt pct AlN) coatings It is universally accepted that both the gra Ni, the cryo Ni, and the cryo (Ni + 0.5 wt pct AlN) coatings
was not observed. The lamellar structure, which is typically
the Hall–Petch equation $H_v = H_0 + kd^{-1/2}$, where H_0 and
observed in thermally sprayed coatings and observed in thermally sprayed coatings, and the lamellar-
structure boundary which resulted as the surface of droplets
solidified^[27] are not clearly visible. However, the cryo (Ni ences 1 through 3) lead to an increase + 2 wt pct AlN) coating (Figure 5(d)) exhibits a distinctive present study, both the grain refinement and the presence of coarse lamellar structure at relatively low magnification. It fine, hard, and dispersed particles pl coarse lamellar structure at relatively low magnification. It fine, hard, and dispersed particles play a role in increasing
is evident that the coarse lamellar structure corresponds to hardness. On the basis of the Hall–Pe is evident that the coarse lamellar structure corresponds to hardness. On the basis of the Hall–Petch equation, the micro-
the spraying pass rather than the surface of droplets solidi-
hardness of the cryo (Ni + 2 wt pct the spraying pass rather than the surface of droplets solidi-
the spraying passes reeded to make the coating are clearly calculated to be 278, assuming approximate grain sizes of fied. The five passes needed to make the coating are clearly calculated to be 278, assuming approximate grain sizes of seen, as a result of oxidation that occurred at the internass $100, 50$,^[12] and 24 nm (Figure 6(a)) seen, as a result of oxidation that occurred at the interpass boundaries (it can be seen from the distribution of oxygen Ni, the cryo Ni, and the cryo (Ni $+$ 2 wt pct AlN) coatings,

that the majority of the grains in the cryo Ni coating were equiaxed, with an average grain size of 50 ± 23 nm.^[12] The ture of the coatings was, therefore, investigated using TEM major contribution to the increase in microhardness result in the present study, and the results are shown in Figure 6. from the addition of fine, hard, and dispe in the present study, and the results are shown in Figure 6. from the addition of fine, hard, and dispersed particles.
Figure 6(a) indicates a typical microstructure of the cryo lndentation-fracture performance is one of t Figure $6(a)$ indicates a typical microstructure of the cryo $(Ni + 2$ wt pct AlN) coating. The majority of grains are important mechanical properties for coatings. Anstis *et al.*^[31] also equiaxed, but with a much smaller average size of 24 established a formula, $K_{IC} = 0.016$ (E/H)^{1/2}($P/c^{3/2}$), to calcu- \pm 15 nm. Fine lamellar structures were observed in areas of the sample of approximately 10 pct (Figure $6(b)$). The fine, equiaxed grains were observed in the areas between *P* is the load, *H* is the Vickers microhardness of the coating, the lamellar structures. Approximately 20 pct of the sample c is the crack length, E is the Young's modulus of the coating, area consisted of even-smaller equiaxed grains with an aver- and K_{IC} is the fracture-toughness value. The aforementioned age size of 16 ± 10 nm, in which a large number of twins

tion was tested with a load of 300 g, and the results are B. Microstructure and Mechanical Properties of the
Coatings compared to that of the conven-
Coatings compared to that of the conven-
tional Ni coating. The addition of 2 wt pct AlN particles, The SEM backscattered electron images in Figures 5(a) however, led to an increase of approximately 60 pct, which
through (d) show the cross-sectional microstructures of the is 10 times as large as the influence of cryomil shown in Figure 11).
The microstructures of the conventional Ni and the cryo Ni average measured value of 378. In fact, even the calculated The microstructures of the conventional Ni and the cryo Ni average measured value of 378. In fact, even the calculated atings were examined using TEM, and the results indicated value of 278 was an overly high estimated val coatings were examined using TEM, and the results indicated value of 278 was an overly high estimated value, because
that the maiority of the grains in the cryo Ni coating were the hardness of nanocrystalline materials has observed to be lower than that predicted using the Hall–Petch equation.^[28,29,30] Therefore, the results suggest that the influence of the presence of AIN particles on the microstruc-
ture of the coatings was, therefore, investigated using TEM major contribution to the increase in microhardness resulted

> late fracture toughness on the basis of mechanics analysis on the cracks caused by Vickers indentation. In this formula, model has been widely and directly applied to the calculation

WD |
10.1 05%AINNi8h

100 um

 10.12 %AINNi8h

Fig. 5—SEM backscattered electron images of the different coatings produced using HVOF. (*a*) Cross section of the conventional Ni coating; (*b*) cross section of the cryo Ni coating; (*c*) cross section of the cryo (Ni + 0.5 wt pct AlN) coating; and (*d*) cross section of the cryo (Ni + 2 wt pct AlN) coating.

that perpendicular to it.^[34] In a material having an isotropic cracks on the cross section of thermally sprayed coatings increased the relative fracture-toughness value. result from a stress-field interaction with large pores or To indicate the influence of the addition of AlN particles process. A complete coating is gradually produced by pass-

of fracture toughness of thermally sprayed coatings, $[32,33]$ discontinuity in the heat and mass transfer may have led regardless of the isotropic-structure requirement of the to a discontinuity in the behavior of coatings. Therefore, model.^[31] However, thermally sprayed coatings have an ani-
sotropic microstructure, e.g., the Young's modulus of properties when parallel to or perpendicular to the coating sotropic microstructure, *e.g.*, the Young's modulus of properties when parallel to or perpendicular to the coating plasma-sprayed WC-12 wt pct Co coatings parallel to the plane. On the basis of the previous arguments, the plasma-sprayed WC-12 wt pct Co coatings parallel to the plane. On the basis of the previous arguments, the fracture-
coating plane was reported to be about twice as large as toughness value obtained by the formula $K_{IC} =$ toughness value obtained by the formula $K_{IC} = 0.016$ (*E*/ H ^{$1/2$} $(P/c^{3/2})$ is considered as a relative fracture toughness microstructure, four symmetrical indentation cracks were in the direction perpendicular to the coating plane (perpen-
observed on the extended lines of the diagonals related to dicular to the crack-propagation plane). For observed on the extended lines of the diagonals related to dicular to the crack-propagation plane). For the present coat-
the quadrilateral pyramid indentation, where a maximum ings, under a 1000 g load, the microhardness the quadrilateral pyramid indentation, where a maximum ings, under a 1000 g load, the microhardness and crack
stress concentration caused by indentation is present.^[31] length were measured from an average reading of 5 t length were measured from an average reading of 5 tests. However, in thermally sprayed coatings, indentation cracks The Young's modulus of all Ni/AlN coatings is estimated usually appear in the direction parallel to the coating plane. to be about 103 GPa,^[35] and the relative fracture-toughness In addition, cracks are not present directly on the extended values were obtained at $K_{IC} = 0.016$ (E/H)^{1/2}($P/c^{3/2}$) and line of the diagonal of the indentation. Instead, indentation are also listed in Table III. The addition of AlN particles

defects located near the impression diagonals. There are no on fracture toughness, illustrative indentation-crack configucracks in the direction perpendicular to the coating rations are shown in Figures 7(a) through (d). Under the plane.^[17,18] The presence of a preferred direction for crack same load, indentation marks in the cryo (Ni + 2 wt pct) initiation and propagation is attributed to the thermal-spray AlN) coating are smaller than those in the conventional Ni
process. A complete coating is gradually produced by pass-
coating, because the former has a higher h ing the thermal-spray torch across the substrate several times. latter. Under a load of 500 g, a crack, located far away from Because each layer had once been the outer surface, there the indentation as shown by the white the indentation as shown by the white arrow, was present is a potential for contamination to occur and to become in the conventional Ni coating. No cracking was observed covered by the next layer. Moreover, at layer boundaries, a around the indentation in the cryo ($Ni + 2$ wt pct AlN)

Fig. 6—TEM images of the cryo ($Ni + 2$ wt pct AlN) coating. (*a*) TEM bright-field image; (*b*) lamellar structure; and (*c*) fine grains with a number much higher than the temperatures of 1300 °C to 1900 °C of twins.
bright-field image; (*b*) lamellar structure; and (*c*) fine grains with

observed in the conventional Ni coating. In contrast, only

Table III. Average Microhardness and Relative Fracture Toughness of the Ni/AlN Coatings

			Cryo	Cryo
			$(Ni + 0.5)$ $(Ni + 2)$	
	Conventional Cryo		Wt Pct	Wt Pct
Code	Ni	Ni	AlN)	AlN)
Hardness (HV_{300})	243	258	304	378
Increase in hard-				
ness (percent)	NA		25	59
K_{IC} (MPa _{\sqrt{m})}	13	14	16	17

a short crack was observed in the cryo $(Ni + 2$ wt pct AlN) coating. Therefore, the present results suggest that the cryo $(Ni + 2$ wt pct AlN) coating possessed a higher fracture toughness relative to that of the conventional Ni coating. It is well known that both the strength/hardness and ductility of conventional materials increases as the grain size decreases. It is reported that the nanocrystalline Al alloy exhibits superplasticity at a relatively high strain rate.^[36] Therefore, grain refinement of the Ni matrix caused by the addition of AlN particles might result in the increase in the relative fracture toughness in the cryo $(Ni + AIN)$ coatings. In addition, the characteristics of the feedstock powder, *i.e.*, the morphology and dimensions of the powder, affect the temperature that the powder experiences during HVOF spraying and, hence, modify coating the toughness by influencing the solidification and oxidation process of splats sprayed on the substrate.^[27] Smaller powder particles lead to a higher powder temperature. The porosity in the coatings depends primarily on the temperature that the powder experiences during spraying, and the higher the powder temperature, the lower the porosity in the coatings and the higher the wear resistance.^[37,38] Thus, unique characteristics of the (*b*) agglomerate size of the ($Ni + 2$ wt pct AlN) powder may benefit the achievement of coatings having a high fracture toughness.

C. *Identification of Particle Phase in Coatings*

The XRD spectra for the four coatings, as well as for the cryomilled ($Ni + 2$ wt pct AlN) powders, are shown in Figure 8. In order to analyze the hard-particle phases with low volume fraction in the coatings, a very slow scan rate of 0.12 deg/min was employed when the XRD experiments were carried out. Even so, AlN particles were not detected in any of the coatings. Moreover, distinctive reflections from the AlN phase were also not observed in the X-ray spectrum for the cryomilled ($Ni + 2$ wt pct AlN) powder, although SEM and TEM observations indicate a uniform distribution of AlN particles in the cryomilled $(Ni + AIN)$ powders (Figures 3 and 4). The failure to detect AlN particles by using XRD does not indicate the absence of AlN particles (*c*) in the coatings. AlN exhibits a melting point of approximately 2800 $\rm^{\circ}C^{[39]}$ and is thermally stable up to 2200 $\rm^{\circ}C$, ^[40] that powders experience during thermal spraying.^[27] Thus, it is presumed that AlN particles were stable during thermal spraying. However, AlN powder is unstable in moist air coating. Under a load of 1000 g, many cracks near the and releases an ammonia odor.^[14] Thermodynamically, the indentation, and even delamination of the coating, were hydrolysis reaction $2AIN + 3H_2O = 2NH_3 + Al_2O_3$ is possible because the free energy (ΔG) of the reaction at

(*c*) (*d*)

Fig. 7—Indentation cracking in coatings. Arrows indicate cracking. (*a*) Conventional Ni coating at 500 g; (*b*) cryo (Ni + 2 wt pct AlN) coating at 500 g; (*c*) conventional Ni coating at 1000 g; and (*d*) cryo (Ni + 2 wt pct AlN) coating at 1000 g.

(Ni $+$ 0.5 wt pct AlN) coating; and (*e*) cryo (Ni $+$ 2 wt pct AlN) coating.

fact, an ammonia odor was detected when the cryomilled $(Ni + AIN)$ powders were sampled. Therefore, it is believed that a trace amount of AlN has decomposed, even though Al_2O_3 was also not detectable by XRD (the angles where the reflections of Al_2O_3 would be also are indicated in Figure 8). It is commonly known that a small amount of light elements (low Z) in a heavy-element (high Z) matrix are invisible due to the absorption of the X-rays.^[42] The intensity of a reflection is proportional to the square of the atomic scattering factor (f) of the diffracted material. The atomic scattering factors of aluminum (the values for AlN and Al_2O_3) are not available) and nickel are listed in Table IV.[42] In addition, the AlN and Al_2O_3 have nanometer sizes and, hence, extensively broadened diffraction peaks that are difficult to be observed.

The presence of NiO phase was confirmed by XRD. Only Fig. 8—XRD spectra for coatings and cryo (Ni + 2 wt pct AlN) powder.

The symbols \Box and \blacksquare indicate the angle where the reflections of AlN and

Al₂O₃ phases would be, respectively. (a) Cryomilled (Ni + 2 wt pct detected in the cryomilled ($Ni + 2$ wt pct AlN) powders, indicating that the NiO observed in the coatings primarily 300 K is calculated to be 332.4 kJ, on the basis of the formed during thermal spraying. The oxidation process thermodynamic data,^[13] and a related study confirmed the occurs rapidly in the presence of oxygen in the surrounding hydrolysis of AlN powder in aqueous environments.^[41] In air and/or excess oxygen during HVOF spraying; particles

Table IV. Atomic Scattering Factors (*f* **) of Nickel and Aluminum**

Sin θ/λ (A ⁻¹) 0.0 0.1 0.2				0.3	0.4	0.5	0.6	0.7	0.8	$0.9 \qquad 1.0$	
Ni Al	28.0	25.0 11.0	20.7 8.95	17.2 7.75		14.6 12.7 11.2 6.6 5.5	4.5	3.7	3.1	9.8 8.7 7.7 7.0 2.65	2.3

Fig. 9—TEM selected-area diffraction pattern of cryo (Ni $+$ 2 wt pct AlN) coating; the arrows indicate diffraction spots from AlN.

exposed to high temperature can oxidize during in-flight Fig. 10—TEM dark-field image of cryo (Ni + 2 wt pct AlN) coating taken and after impingement onto the substrate surface.^[43] The by using {111} NiO, indicating NiO particles. formation of an oxide layer comprises the complex processes of adsorption of oxygen molecules on the material surface,

is shown in Figure 9. The diffraction patterns from the AlN is reasonably assumed that the cryo (
phase were imaged and are indicated by the arrows. The coating consists of \sim 5 vol pct AlN, \sim 4
diffraction patterns fr and very close to those from the Ni matrix and NiO phase, and the strongest diffraction of ${100}_{\text{AlN}}$ was covered in the range of the illumination from the central transmission spot. **IV. CONCLUSIONS** This led to unsuccessful attempts to take dark-field images of the AlN phase with the purpose of exhibiting the dimen- In the present study, nanocrystalline Ni powders con-

dissociation of the oxygen molecules, formation of oxide
nuclei, a dark-field image was taken and is shown in
nuclei, andly, the growth of nuclei to form a complete
nuclei to form a complete
HVOF spraying depends on the o coating consists of \sim 5 vol pct AlN, \sim 4 vol pct NiO, a trace

sions and the distribution of particles. Using the $\{111\}_{\text{NiO}}$ taining ultrafine AlN particles were synthesized by using

Fig. 11-Distributions of oxygen and aluminum on cross section of the cryo (Ni + 2 wt pct AlN) coating. (*a*) SEM secondary electron image; (*b*) 7. R.J. Perez, H.G. Jiang, C.P. Dogan, and X-ray mapping of aluminum. *Trans. A*, 1998, vol. 29A, pp. 2469-75. X-ray mapping of oxygen; and (*c*) X-ray mapping of aluminum.

cryomilling. The resultant powders were employed as feeds-
tock powders to fabricate hard-particle-strengthened nano-
crystalline Ni coatings. The results are briefly summarized
as follows.
as follows.

1. The ability to introduce a secondary nitride phase into Ni and E.J. Lavernia: *J. Mater. Res.*, 2002, vol. 17, pp. 1041-49.
using AIN additions has been successfully demonstrated. 13. E.A. Brands and G.B. Brook: *Smithe*

The presence of this secondary phase led to improved mechanical behavior in HVOF coatings, as desired and predicted.

- 2. The AlN additive was reduced in size from a starting powder size of 2 μ m to ultrafine particles of approximately 30 nm in diameter. These particles were dispersively embedded into the Ni matrix and enhanced the development of a nanocrystalline structure in the Ni matrix during cryomilling.
- 3. The presence of AlN particles in the powders decreased the agglomerate size and increased the surface roughness of the agglomerates.
- 4. The addition of AlN also led to an increase in the amount of NiO phase that was distributed in the coatings in the form of ultrafine, round particles.
- 5. A decreased grain size was achieved in the AlN-strength- (*a*) ened Ni coating, compared to the cryo Ni coatings. Smaller initial grains in the feedstock powder caused by the addition of AlN and the increase in the amount of the dispersed, ultrafine particles (AlN and NiO) that inhibit grain growth were attributed to the observed smaller grain size in the AlN-strengthened Ni coating.
	- 6. Compared with that of the cryomilled Ni coating, an increase in microhardness by 18 and 47 pct was obtained for the additions of 0.5 and 2 wt pct AlN, respectively. Indentation-fracture results also indicated that the fine, dispersed AlN particles raised the apparent toughness of the Ni coating. The increase in microhardness resulted from both grain refinement and the presence of ultrafine particles. However, the latter played the primary role in strengthening.

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REFERENCES

- 1. N.F. Mott and F.R.N. Nabarro: *Proc. Phys. Soc.*, 1940, vol. 52, p. 86.
- 2. E. Orowan: *Symp. on Internal Stress in Metals and Alloys: Session III Discussion*, Institute of Metals, London, 1948, p. 451.
- 3. A.J. Ardell: *Metall. Trans. A*, 1985, vol. 16A, pp. 2131-65.
- 4. C.S. Smith: *Trans. AIME*, 1948, vol. 175, pp. 15-51.
- 5. D.G. Morris and M.A. Morris: *Acta Metall. Mater.*, 1991, vol. 39, pp. 1763-70.
- 6. M.J. Luton, C.S. Jayanth, M.M. Disco, S. Matras, and J. Vallone: in *Multicomponent Ultrafine Microstructures*, L.E. McCandlish, B.H.

and aluminum on cross section of the
 Ca) Kear, D.E. Polk, and R.W. Siegel, eds., Materials Research Society,
 Ca) SEM secondary electron image; *(b)*
	-
	- 8. B. Huang, J. Vallone, and M.J. Luton: *Nanostr. Mater.*, 1995, vol. 5, pp. 631-42.
	- 9. J.D. Whittenberger and M.J. Luton: *J. Mater. Res.*, 1995, vol. 10, pp.
	-
	- *Thermal Spray Technol.*, 2001, vol. 10, pp. 293-300.
M.L. Lau, J. He, A.J. Melmed, T.A. Lusby, R. Schweinfest, M. Ruhle,
	-
	- 13. E.A. Brands and G.B. Brook: *Smithells Metals Reference Book*, 7th

ed., Butterworth-Heinemann, Oxford, United Kingdom, 1992, pp. 8:23-8:26.

- 14. Certificate of Analysis comes with the AlN powder, CERAC Inc., Milwaukee, WI, 2001.
- 15. F.G. Wilson and T. Gladman: *Int. Mater. Rev.*, 1988, vol. 33, pp. 221-86.
- 16. M.L. Bauccio: *Metals Reference Book*, 3rd ed., ASM INTERNA-TIONAL, Materials Park, OH, 1999, p. 153.
- 17. J. He, M. Ice, S. Dallek, and E.J. Lavernia: *Metall. Mater. Trans. A*, 2000, vol. 31A, pp. 541-53.
- 18. J. He, M. Ice, and E.J. Lavernia: *Metall. Mater. Trans. A*, 2000, vol. 31A, pp. 555-64.
- 19. J. He, K.H. Chung, X. Liao, Y.T. Zhu, and E.J. Lavernia: *Metall. Mater. Trans. A*, 2003, vol. 34A, pp. 707-12.
- 20. J. He, L. Ajdelsztajn, and E.J. Lavernia: *J. Mater. Res.*, 2001, vol. 16, pp. 478-88.
- 21. J. He, M. Ice, and E.J. Lavernia: *Nanostr. Mater.*, 1998, vol. 10, pp. 1271-83.
- 22. J. He and E.J. Lavernia: *J. Mater. Res.*, 2001, vol. 16, pp. 2724-32.
- 23. H.P. Klug and L.E. Alexander: *X-ray Diffraction Procedures*, John Wiley & Sons, New York, NY, 1974, p. 643.
- 24. X. Zhang, H. Wang, J. Narayan, and C.C. Koch: *Acta Mater.*, 2001, vol. 49, pp. 1319-26.
- 25. J. Xu, J.H. He, and E. Ma: *Metall. Mater. Trans. A*, 1997, vol. 28A, pp. 1569-80.
- 26. J.S. Benjamin: *Metall. Trans.* 1970, vol. 1, pp. 2943-51.
- 27. J. He, M. Ice, and E.J. Lavernia: *J. Thermal Spray Technol.*, 2000, vol. 10, pp. 83-93.
- 28. X.D. Liu, M. Nagumo, and M. Umemoto: *Mater. Trans., JIM*, 1997, vol. 38, pp. 1033-39.
- 29. C. Suryanarayana, D. Mukhopadhyay, S.N. Patankar, and F.H. Froes: *J. Mater. Res.*, 1992, vol. 7, pp. 2114-17.
- 30. D.A. Konstantinidis and E.C. Aifantis: *NanoStructured Mater.*, 1998, vol. 10, pp. 1111-18.
- 31. G.R. Anstis, P. Chantikul, B.R. Lawn, and D.B. Marshall: *J. Am. Ceram. Soc.* 1981, vol. 64, pp. 533-38.
- 32. V. Fervel, B. Normand, and C. Coddet: *Wear*, 1999, vol. 230, pp. 70-77.
- 33. H. Li, K.A. Khor, and P. Cheang: *Surf. Coating Technol.*, 2002, vol. 155, pp. 21-32.
- 34. H. Nakahira, K. Tani, K. Miyajima, and Y. Harada: *Proc. Int. Thermal Spray Conf. Exp.*, Orlando, Fl, May 28–June 5, 1992, C.C. Berndt, ed., ASM International, Materials Park, OH, 1992, pp. 1011-17.
- 35. T. Gnaupel-Herold and H.J. Prask: *Annual Report*, 2000, National Institute of Standards and Technology, United States Department of Commerce, Gaithersburg, MD, pp. 28-29.
- 36. R.S. Mishra, M.W. Mahoney, S.X. McFadden, N.A. Mara, and A.K. Mukherjee: *Scripta Mater.*, 2000, vol. 42, pp. 163-68.
- 37. J. He, Y. Liu, Y. Qiao, T.E. Fischer, and E.J. Lavernia: *Metall. Mater. Trans. A*, 2002, vol. 33A, pp. 145-57.
- 38. Y. Liu, Y. Qiao, J. He, E.J. Lavernia, and T.E. Fischer: *Metall. Mater. Trans. A*, 2002, vol. 33A, pp. 159-64.
- 39. H.A. Wriedt: in *Binary Alloy Phase Diagrams,* 2nd ed., T.B. Massalski, ed., ASM INTERNATIONAL, Materials Park, OH, 1990, p. 176.
- 40. F. Benesovsky: in *Encyclopedia of Chemical Technology*, 3rd ed., M. Grayson, ed., John Wiley & Sons, New York, NY, 1978, vol. 15, p. 876.
- 41. S. Novak and T. Kosmac: *J. Mater. Res.*, 2002, vol. 17, pp. 445-50.
- 42. B.D. Gullity: *Elements of X-ray Diffraction*, Addison-Wesley Publishing Co., Inc., Reading, MA, 1959, p. 474.
- 43. V.V. Sobolev, J.M. Guilemany, J. Nutting, and J.R. Miquel: *Int. Mater. Rev.*, 1997, vol. 42, pp. 117-36.
- 44. P. Scharwaechter, M. Wimmer, R. Wurschum, D. Plachke, and H.D. Carstanjen: *Nanostr. Mater.*, 1999, vol. 11, pp. 37-42.